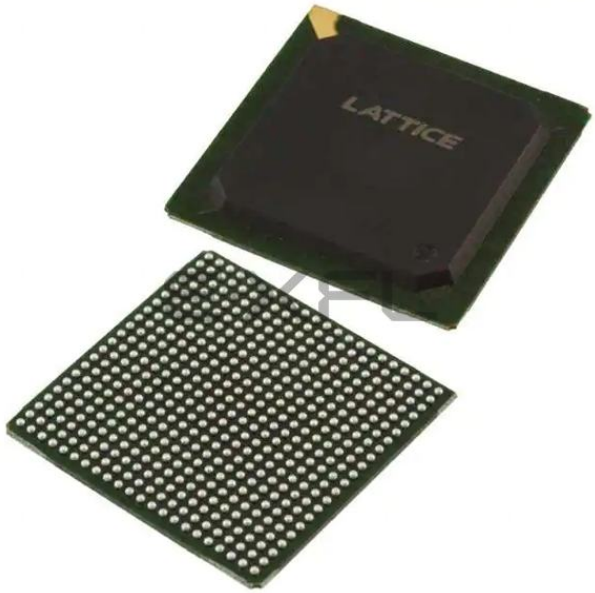

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

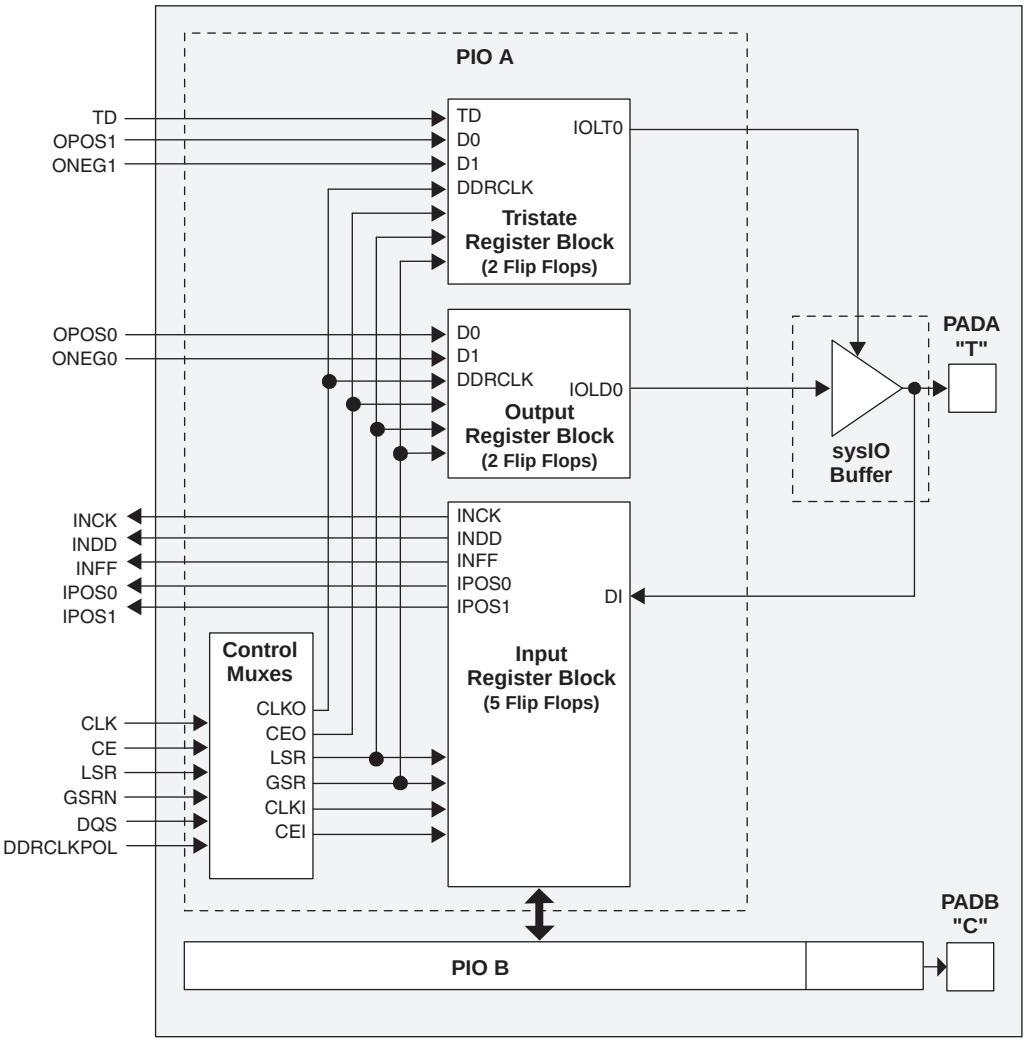
Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	19700
Total RAM Bits	434176
Number of I/O	360
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec20e-3fn484c

For further information about the sysDSP block, please see the list of technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O Buffers which are then connected to the PADs as shown in Figure 2-24. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to sysI/O buffer, and receives input from the buffer.

Figure 2-24. PIC Diagram



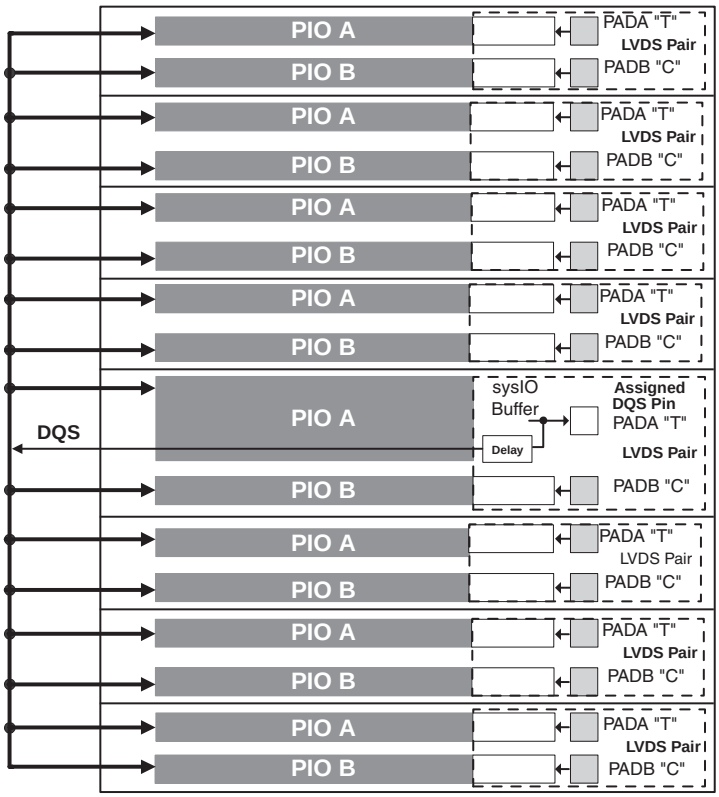
Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-25. The PAD Labels “T” and “C” distinguish the two PIOs. Only the PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs.

One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus which spans the set of 16 PIOs. Figure 2-25 shows the assignment of DQS pins in each set of 16 PIOs. The exact DQS pins are shown in a dual function in the Logic Signal Connections table at the end of this data sheet. Additional detail is provided in the Signal Descriptions table at the end of this data sheet. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. This interface is designed for memories that support one DQS strobe per eight bits of data.

Table 2-12. PIO Signal List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block FFs.
CLK0, CLK1	Control from the core	System clocks for input and output blocks.
LSR	Control from the core	Local Set/Reset.
GSRN	Control from routing	Global Set/Reset (active low).
INCK	Input to the core	Input to Primary Clock Network or PLL reference inputs.
DQS	Input to PIO	DQS signal from logic (routing) to PIO.
INDD	Input to the core	Unregistered data input to core.
INFF	Input to the core	Registered input on positive edge of the clock (CLK0).
IPOS0, IPOS1	Input to the core	DDRX registered inputs to the core.
ONEG0	Control from the core	Output signals from the core for SDR and DDR operation.
OPOS0,	Control from the core	Output signals from the core for DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation.
TD	Tristate control from the core	Tristate signal from the core used in SDR operation.
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block.

Figure 2-25. DQS Routing



PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for both single data rate (SDR) and double data rate (DDR) operation along with the necessary clock and selection logic. Programmable delay lines used to shift incoming clock and data signals are also included in these blocks.

be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

Oscillator

Every LatticeECP/EC device has an internal CMOS oscillator which is used to derive a master clock for configuration. The oscillator and the master clock run continuously. The default value of the master clock is 2.5MHz. Table 2-15 lists all the available Master Clock frequencies. When a different Master Clock is selected during the design process, the following sequence takes place:

1. User selects a different Master Clock frequency.
2. During configuration the device starts with the default (2.5MHz) Master Clock frequency.
3. The clock configuration settings are contained in the early configuration bit stream.
4. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.

For further information about the use of this oscillator for configuration, please see the list of technical documentation at the end of this data sheet.

Table 2-15. Selectable Master Clock (CCLK) Frequencies During Configuration

CCLK (MHz)	CCLK (MHz)	CCLK (MHz)
2.5*	13	45
4.3	15	51
5.4	20	55
6.9	26	60
8.1	30	130
9.2	34	—
10.0	41	—

Density Shifting

The LatticeECP/EC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

sysI/O Differential Electrical Characteristics

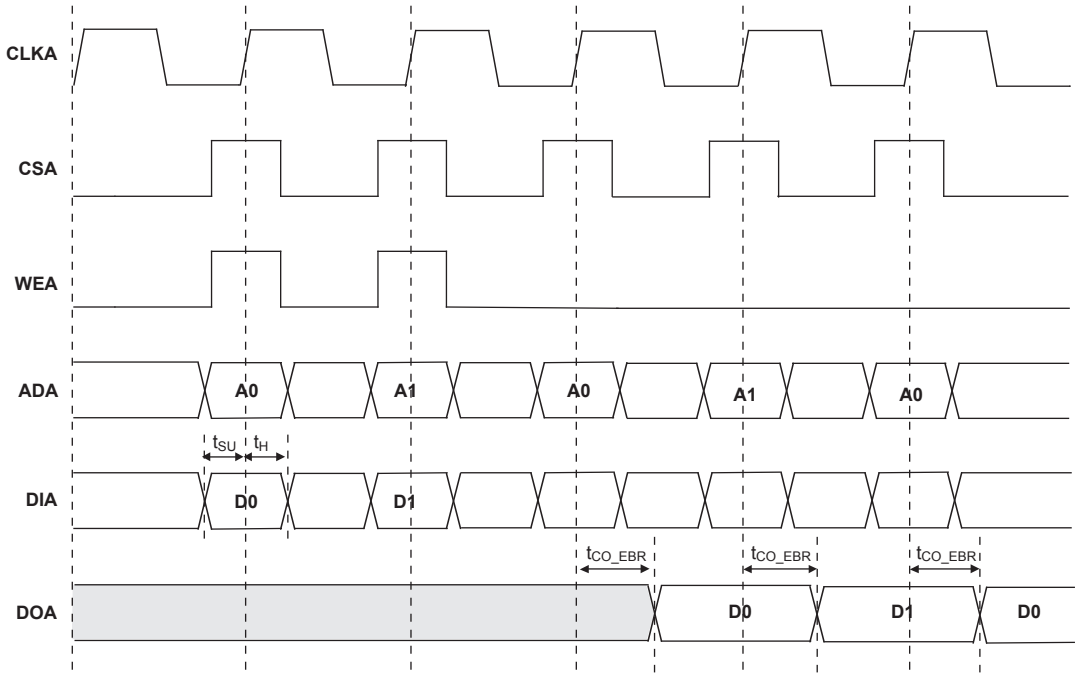
LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold		+/-100	—	—	mV
V_{CM}	Input common mode voltage	100mV ð V_{THD}	V_{THD}/2	1.2	1.8	V
		200mV ð V_{THD}	V_{THD}/2	1.2	1.9	V
		350mV ð V_{THD}	V_{THD}/2	1.2	2.0	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	µA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	0.9V	1.03	—	V
V_{OD}	Output voltage differential	(V_{OP} - V_{OM}), R_T = 100 Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	(V_{OP} + V_{OM})/2, R_T = 100 Ohm	1.125	1.25	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{OSD}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	6	mA

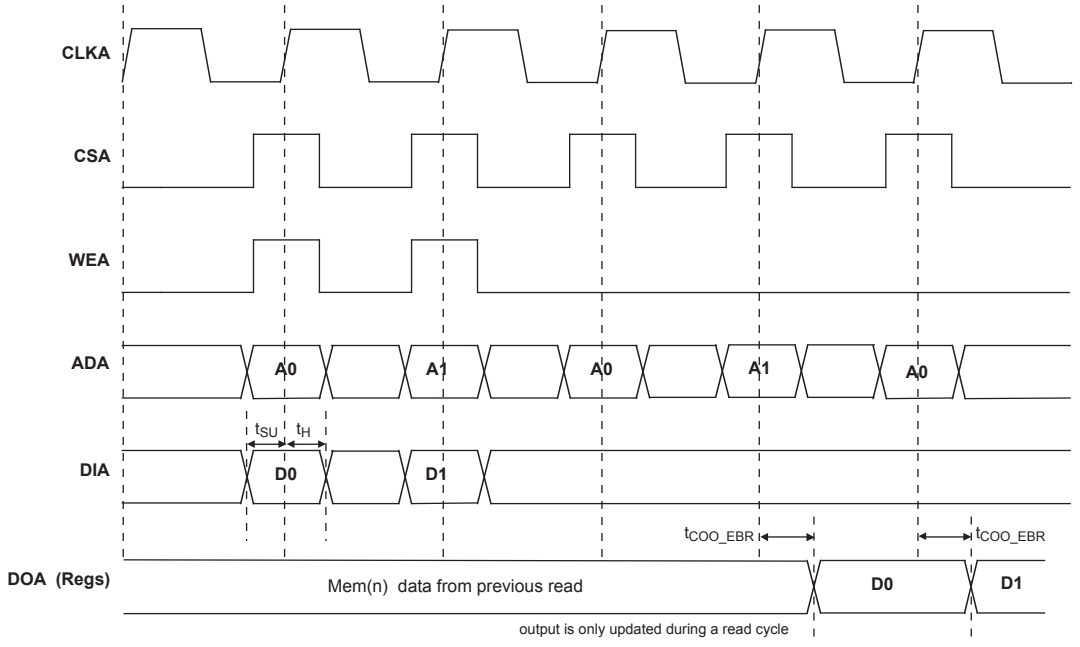
EBR Memory Timing Diagrams

Figure 3-8. Read/Write Mode (Normal)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

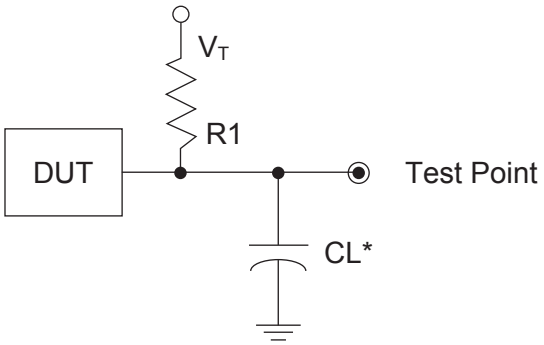
Figure 3-9. Read/Write Mode with Input and Output Registers



Switching Test Conditions

Figure 3-21 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-6.

Figure 3-21. Output Test Load, LVTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-6. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	R_1	C_L	Timing Ref.	V_T
LVTTL and other LVCMOS settings (L -> H, H -> L)	∞	0pF	LVCMOS 3.3 = 1.5V	—
			LVCMOS 2.5 = $V_{CCIO}/2$	—
			LVCMOS 1.8 = $V_{CCIO}/2$	—
			LVCMOS 1.5 = $V_{CCIO}/2$	—
			LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	188¾	0pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)			$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)			V_{OH} - 0.15	V_{OL}
LVCMOS 2.5 I/O (L -> Z)			V_{OL} + 0.15	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
127	CFG0	3			CFG0	3		
128	VCC	-			VCC	-		
129	PROGRAMN	3			PROGRAMN	3		
130	CCLK	3			CCLK	3		
131	INITN	3			INITN	3		
132	GND	-			GND	-		
133	DONE	3			DONE	3		
134	GND	-			GND	-		
135	VCC	-			VCC	-		
136	NC	-			VCCAUX	-		
137	PR5B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
138	NC	-			GND2	2		
139	PR5A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
140	PR4B	2	C		PR8B	2	C	
141	PR4A	2	T		PR8A	2	T	
142	PR3B	2	C		PR7B	2	C	
143	PR3A	2	T		PR7A	2	T	
144	NC	-			PR6B	2	C	
145	NC	-			VCCIO2	2		
146	NC	-			PR6A	2	T	RDQS6
147	NC	-			PR5B	2	C	
148	NC	-			PR5A	2	T	
149	NC	-			PR4B	2	C	
150	NC	-			PR4A	2	T	
151	NC	-			NC	-		
152	NC	-			NC	-		
153	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
154	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
155	VCCIO2	2			VCCIO2	2		
156*	GND1 GND2	-			GND1 GND2	-		
157	VCCIO1	1			VCCIO1	1		
158	NC	-			NC	-		
159	PT17B	1	C		PT25B	1	C	
160	PT17A	1	T		PT25A	1	T	
161	PT16B	1	C		PT24B	1	C	
162	PT16A	1	T		PT24A	1	T	
163	PT15B	1	C		PT23B	1	C	
164	PT15A	1	T		PT23A	1	T	
165	PT14B	1	C		PT22B	1	C	
166	PT14A	1	T	TDQS14	PT22A	1	T	TDQS22
167	PT13B	1	C		PT21B	1	C	
168	GND1	1			GND1	1		

LFECP/EC6, LFECP/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFECP6/LFEC6				LFECP10/LFEC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT21A	1	T		PT29A	1	T	
170	PT20B	1	C		PT28B	1	C	
171	PT20A	1	T		PT28A	1	T	
172	PT19B	1	C	VREF2_1	PT27B	1	C	VREF2_1
173	PT19A	1	T	VREF1_1	PT27A	1	T	VREF1_1
174	PT18B	1	C		PT26B	1	C	
175	PT18A	1	T		PT26A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT17B	0	C	PCLKC0_0	PT25B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT17A	0	T	PCLKT0_0	PT25A	0	T	PCLKT0_0
181	PT16B	0	C	VREF1_0	PT24B	0	C	VREF1_0
182	PT16A	0	T	VREF2_0	PT24A	0	T	VREF2_0
183	PT15B	0	C		PT23B	0	C	
184	PT15A	0	T		PT23A	0	T	
185	PT14B	0	C		PT22B	0	C	
186	PT14A	0	T	TDQS14	PT22A	0	T	TDQS22
187	VCCIO0	0			VCCIO0	0		
188	PT13B	0	C		PT21B	0	C	
189	GND0	0			GND0	0		
190	PT13A	0	T		PT21A	0	T	
191	PT12B	0	C		PT20B	0	C	
192	PT12A	0	T		PT20A	0	T	
193	PT11B	0	C		PT19B	0	C	
194	PT11A	0	T		PT19A	0	T	
195	PT10B	0	C		PT18B	0	C	
196	PT10A	0	T		PT18A	0	T	
197	VCCIO0	0			VCCIO0	0		
198	PT6B	0	C		PT6B	0	C	
199	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
200	PT5B	0	C		PT5B	0	C	
201	PT5A	0	T		PT5A	0	T	
202	PT4B	0	C		PT4B	0	C	
203	PT4A	0	T		PT4A	0	T	
204	PT3B	0	C		PT3B	0	C	
205	PT3A	0	T		PT3A	0	T	
206	PT2B	0	C		PT2B	0	C	
207	PT2A	0	T		PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

*Double bonded to the pin.

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
W17	NC	-			W17	NC	-			W17	PB46B	4	C	
AA20	NC	-			AA20	NC	-			AA20	PB47A	4	T	
Y19	NC	-			Y19	NC	-			Y19	PB47B	4	C	
Y18	NC	-			Y18	NC	-			Y18	PB48A	4	T	
W18	NC	-			W18	NC	-			W18	PB48B	4	C	
T17	NC	-			T17	NC	-			T17	PB49A	4	T	
U17	NC	-			U17	NC	-			U17	PB49B	4	C	
GND	GND4	4			GND	GND4	4			GND	GND4	4		
GND	GND3	3			GND	GND3	3			GND	GND3	3		
W20	PR27B	3	C	VREF2_3	W20	PR36B	3	C	VREF2_3	W20	PR44B	3	C	VREF2_3
Y20	PR27A	3	T	VREF1_3	Y20	PR36A	3	T	VREF1_3	Y20	PR44A	3	T	VREF1_3
AA21	PR26B	3	C		AA21	PR35B	3	C		AA21	PR43B	3	C	
AB21	PR26A	3	T		AB21	PR35A	3	T		AB21	PR43A	3	T	
W19	PR25B	3	C		W19	PR34B	3	C		W19	PR42B	3	C	
V19	PR25A	3	T		V19	PR34A	3	T		V19	PR42A	3	T	
Y21	PR24B	3	C		Y21	PR33B	3	C		Y21	PR41B	3	C	
AA22	PR24A	3	T	RDQS24	AA22	PR33A	3	T	RDQS33	AA22	PR41A	3	T	RDQS41
V20	PR23B	3	C	RLM0_PLLC_FB_A	V20	PR32B	3	C	RLM0_PLLC_FB_A	V20	PR40B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND	GND3	3			GND	GND3	3		
U20	PR23A	3	T	RLM0_PLLT_FB_A	U20	PR32A	3	T	RLM0_PLLT_FB_A	U20	PR40A	3	T	RLM0_PLLT_FB_A
W21	PR22B	3	C	RLM0_PLLC_IN_A	W21	PR31B	3	C	RLM0_PLLC_IN_A	W21	PR39B	3	C	RLM0_PLLC_IN_A
Y22	PR22A	3	T	RLM0_PLLT_IN_A	Y22	PR31A	3	T	RLM0_PLLT_IN_A	Y22	PR39A	3	T	RLM0_PLLT_IN_A
V21	PR21B	3	C	DI/CSSPIN	V21	PR30B	3	C	DI/CSSPIN	V21	PR38B	3	C	DI/CSSPIN
W22	PR21A	3	T	DOUT/CSON	W22	PR30A	3	T	DOUT/CSON	W22	PR38A	3	T	DOUT/CSON
U21	PR20B	3	C	BUSY/SISPI	U21	PR29B	3	C	BUSY/SISPI	U21	PR37B	3	C	BUSY/SISPI
V22	PR20A	3	T	D7/SPID0	V22	PR29A	3	T	D7/SPID0	V22	PR37A	3	T	D7/SPID0
T19	CFG2	3			T19	CFG2	3			T19	CFG2	3		
U19	CFG1	3			U19	CFG1	3			U19	CFG1	3		
U18	CFG0	3			U18	CFG0	3			U18	CFG0	3		
V18	PROGRAMN	3			V18	PROGRAMN	3			V18	PROGRAMN	3		
T20	CCLK	3			T20	CCLK	3			T20	CCLK	3		
T21	INITN	3			T21	INITN	3			T21	INITN	3		
R20	DONE	3			R20	DONE	3			R20	DONE	3		
T18	NC	-			T18	NC	-			T18	NC	-		
R17	NC	-			R17	NC	-			R17	NC	-		
R19	NC	-			R19	NC	-			R19	NC	-		
R18	NC	-			R18	NC	-			R18	NC	-		
U22	NC	-			U22	NC	-			U22	PR35B	3	C	
GND	-	-			GND	-	-			GND	GND3	3		
T22	NC	-			T22	NC	-			T22	PR35A	3	T	
R21	NC	-			R21	NC	-			R21	PR34B	3	C	
R22	NC	-			R22	NC	-			R22	PR34A	3	T	
P20	NC	-			P20	NC	-			P20	PR33B	3	C	
N20	NC	-			N20	NC	-			N20	PR33A	3	T	
P19	NC	-			P19	NC	-			P19	PR32B	3	C	
P18	NC	-			P18	NC	-			P18	PR32A	3	T	
P21	PR18B	3	C		P21	PR27B	3	C		P21	PR31B	3	C	
GND	GND3	3			GND	GND3	3			GND	GND3	3		
P22	PR18A	3	T		P22	PR27A	3	T		P22	PR31A	3	T	
N21	PR17B	3	C		N21	PR26B	3	C		N21	PR30B	3	C	

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
C21	NC	-			C21	PR5B	2	C		C21	PR5B	2	C	
C20	NC	-			C20	PR5A	2	T		C20	PR5A	2	T	
F18	NC	-			F18	PR4B	2	C		F18	PR4B	2	C	
E18	NC	-			E18	PR4A	2	T		E18	PR4A	2	T	
B22	NC	-			B22	PR3B	2	C		B22	PR3B	2	C	
B21	NC	-			B21	PR3A	2	T		B21	PR3A	2	T	
E19	PR2B	2	C	VREF1_2	E19	PR2B	2	C	VREF1_2	E19	PR2B	2	C	VREF1_2
D19	PR2A	2	T	VREF2_2	D19	PR2A	2	T	VREF2_2	D19	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1			GND	GND1	1		
G17	NC	-			G17	NC	-			G17	PT49B	1	C	
F17	NC	-			F17	NC	-			F17	PT49A	1	T	
D18	NC	-			D18	NC	-			D18	PT48B	1	C	
C18	NC	-			C18	NC	-			C18	PT48A	1	T	
C19	NC	-			C19	NC	-			C19	PT47B	1	C	
B20	NC	-			B20	NC	-			B20	PT47A	1	T	
D17	NC	-			D17	NC	-			D17	PT46B	1	C	
C16	NC	-			C16	NC	-			C16	PT46A	1	T	TDQS46
B19	NC	-			B19	NC	-			B19	PT45B	1	C	
GND	-	-			GND	-	-			GND	GND1	1		
A20	NC	-			A20	NC	-			A20	PT45A	1	T	
E17	NC	-			E17	NC	-			E17	PT44B	1	C	
C17	NC	-			C17	NC	-			C17	PT44A	1	T	
F16	NC	-			F16	NC	-			F16	PT43B	1	C	
E16	NC	-			E16	NC	-			E16	PT43A	1	T	
F15	NC	-			F15	NC	-			F15	PT42B	1	C	
D16	NC	-			D16	NC	-			D16	PT42A	1	T	
B18	PT33B	1	C		B18	PT41B	1	C		B18	PT41B	1	C	
GND	-	-			GND	-	-			GND	GND1	1		
A19	PT33A	1	T		A19	PT41A	1	T		A19	PT41A	1	T	
B17	PT32B	1	C		B17	PT40B	1	C		B17	PT40B	1	C	
A18	PT32A	1	T		A18	PT40A	1	T		A18	PT40A	1	T	
B16	PT31B	1	C		B16	PT39B	1	C		B16	PT39B	1	C	
A17	PT31A	1	T		A17	PT39A	1	T		A17	PT39A	1	T	
B15	PT30B	1	C		B15	PT38B	1	C		B15	PT38B	1	C	
A16	PT30A	1	T	TDQS30	A16	PT38A	1	T	TDQS38	A16	PT38A	1	T	TDQS38
A15	PT29B	1	C		A15	PT37B	1	C		A15	PT37B	1	C	
GND	GND1	1			GND	GND1	1			GND	GND1	1		
A14	PT29A	1	T		A14	PT37A	1	T		A14	PT37A	1	T	
G14	PT28B	1	C		G14	PT36B	1	C		G14	PT36B	1	C	
E15	PT28A	1	T		E15	PT36A	1	T		E15	PT36A	1	T	
D15	PT27B	1	C		D15	PT35B	1	C		D15	PT35B	1	C	
C15	PT27A	1	T		C15	PT35A	1	T		C15	PT35A	1	T	
C14	PT26B	1	C		C14	PT34B	1	C		C14	PT34B	1	C	
B14	PT26A	1	T		B14	PT34A	1	T		B14	PT34A	1	T	
A13	PT25B	1	C		A13	PT33B	1	C		A13	PT33B	1	C	
GND	GND1	1			GND	GND1	1			GND	GND1	1		
B13	PT25A	1	T		B13	PT33A	1	T		B13	PT33A	1	T	
E14	PT24B	1	C		E14	PT32B	1	C		E14	PT32B	1	C	
C13	PT24A	1	T		C13	PT32A	1	T		C13	PT32A	1	T	

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A4	NC	-			A4	PT9B	0	C		A4	PT9B	0	C	
B4	NC	-			B4	PT9A	0	T		B4	PT9A	0	T	
C4	NC	-			C4	PT8B	0	C		C4	PT8B	0	C	
C5	NC	-			C5	PT8A	0	T		C5	PT8A	0	T	
D6	NC	-			D6	PT7B	0	C		D6	PT7B	0	C	
B5	NC	-			B5	PT7A	0	T		B5	PT7A	0	T	
E6	NC	-			E6	PT6B	0	C		E6	PT6B	0	C	
C6	NC	-			C6	PT6A	0	T	TDQS6	C6	PT6A	0	T	TDQS6
A3	NC	-			A3	PT5B	0	C		A3	PT5B	0	C	
B3	NC	-			B3	PT5A	0	T		B3	PT5A	0	T	
F6	NC	-			F6	PT4B	0	C		F6	PT4B	0	C	
D5	NC	-			D5	PT4A	0	T		D5	PT4A	0	T	
F7	NC	-			F7	PT3B	0	C		F7	PT3B	0	C	
E8	NC	-			E8	PT3A	0	T		E8	PT3A	0	T	
G6	NC	-			G6	PT2B	0	C		G6	PT2B	0	C	
E7	NC	-			E7	PT2A	0	T		E7	PT2A	0	T	
GND	-	-			GND	GND0	0			GND	GND0	0		
A1	GND	-			A1	GND	-			A1	GND	-		
A22	GND	-			A22	GND	-			A22	GND	-		
AB1	GND	-			AB1	GND	-			AB1	GND	-		
AB22	GND	-			AB22	GND	-			AB22	GND	-		
H15	GND	-			H15	GND	-			H15	GND	-		
H8	GND	-			H8	GND	-			H8	GND	-		
J10	GND	-			J10	GND	-			J10	GND	-		
J11	GND	-			J11	GND	-			J11	GND	-		
J12	GND	-			J12	GND	-			J12	GND	-		
J13	GND	-			J13	GND	-			J13	GND	-		
J14	GND	-			J14	GND	-			J14	GND	-		
J9	GND	-			J9	GND	-			J9	GND	-		
K10	GND	-			K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-			K14	GND	-		
K9	GND	-			K9	GND	-			K9	GND	-		
L10	GND	-			L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-			L14	GND	-		
L9	GND	-			L9	GND	-			L9	GND	-		
M10	GND	-			M10	GND	-			M10	GND	-		
M11	GND	-			M11	GND	-			M11	GND	-		
M12	GND	-			M12	GND	-			M12	GND	-		
M13	GND	-			M13	GND	-			M13	GND	-		
M14	GND	-			M14	GND	-			M14	GND	-		
M9	GND	-			M9	GND	-			M9	GND	-		
N10	GND	-			N10	GND	-			N10	GND	-		
N11	GND	-			N11	GND	-			N11	GND	-		
N12	GND	-			N12	GND	-			N12	GND	-		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
V2	PL41B	6	C	LLM0_PLLC_IN_A	V2	PL53B	6	C	LLM0_PLLC_IN_A
U3	PL42A	6	T	LLM0_PLLT_FB_A	U3	PL54A	6	T	LLM0_PLLT_FB_A
V3	PL42B	6	C	LLM0_PLLC_FB_A	V3	PL54B	6	C	LLM0_PLLC_FB_A
U4	PL43A	6	T		U4	PL55A	6	T	
V5	PL43B	6	C		V5	PL55B	6	C	
W1	PL44A	6	T		W1	PL56A	6	T	
GND	GND6	6			GND	GND6	6		
W2	PL44B	6	C		W2	PL56B	6	C	
Y1	PL45A	6	T	LDQS45	Y1	PL57A	6	T	LDQS57
Y2	PL45B	6	C		Y2	PL57B	6	C	
AA1	PL46A	6	T		AA1	PL58A	6	T	
AA2	PL46B	6	C		AA2	PL58B	6	C	
W4	PL47A	6	T		W4	PL59A	6	T	
V4	PL47B	6	C		V4	PL59B	6	C	
W3	PL48A	6	T	VREF1_6	W3	PL68A	6	T	VREF1_6
Y3	PL48B	6	C	VREF2_6	Y3	PL68B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6		
GND	GND5	5			GND	GND6	6		
GND	-				GND	GND6	6		
GND	-				GND	GND5	5		
GND	GND5	5			GND	GND5	5		
V7	PB10A	5	T		V7	PB10A	5	T	
T6	PB10B	5	C		T6	PB10B	5	C	
V8	PB11A	5	T		V8	PB11A	5	T	
U7	PB11B	5	C		U7	PB11B	5	C	
W5	PB12A	5	T		W5	PB12A	5	T	
U6	PB12B	5	C		U6	PB12B	5	C	
AA3	PB13A	5	T		AA3	PB13A	5	T	
GND	GND5	5			GND	GND5	5		
AB3	PB13B	5	C		AB3	PB13B	5	C	
Y6	PB14A	5	T	BDQS14	Y6	PB14A	5	T	BDQS14
V6	PB14B	5	C		V6	PB14B	5	C	
AA5	PB15A	5	T		AA5	PB15A	5	T	
W6	PB15B	5	C		W6	PB15B	5	C	
Y5	PB16A	5	T		Y5	PB16A	5	T	
Y4	PB16B	5	C		Y4	PB16B	5	C	
AA4	PB17A	5	T		AA4	PB17A	5	T	
GND	GND5	5			GND	GND5	5		
AB4	PB17B	5	C		AB4	PB17B	5	C	
Y7	PB18A	5	T		Y7	PB18A	5	T	
W8	PB18B	5	C		W8	PB18B	5	C	
W7	PB19A	5	T		W7	PB19A	5	T	
U8	PB19B	5	C		U8	PB19B	5	C	
W9	PB20A	5	T		W9	PB20A	5	T	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A7	PT27B	0	C		A7	PT27B	0	C	
A6	PT27A	0	T		A6	PT27A	0	T	
B7	PT26B	0	C		B7	PT26B	0	C	
B8	PT26A	0	T		B8	PT26A	0	T	
A5	PT25B	0	C		A5	PT25B	0	C	
GND	GND0	0			GND	GND0	0		
B6	PT25A	0	T		B6	PT25A	0	T	
G10	PT24B	0	C		G10	PT24B	0	C	
E10	PT24A	0	T		E10	PT24A	0	T	
F10	PT23B	0	C		F10	PT23B	0	C	
D10	PT23A	0	T		D10	PT23A	0	T	
G9	PT22B	0	C		G9	PT22B	0	C	
E9	PT22A	0	T	TDQS22	E9	PT22A	0	T	TDQS22
C9	PT21B	0	C		C9	PT21B	0	C	
GND	GND0	0			GND	GND0	0		
C8	PT21A	0	T		C8	PT21A	0	T	
F9	PT20B	0	C		F9	PT20B	0	C	
D9	PT20A	0	T		D9	PT20A	0	T	
F8	PT19B	0	C		F8	PT19B	0	C	
D7	PT19A	0	T		D7	PT19A	0	T	
D8	PT18B	0	C		D8	PT18B	0	C	
C7	PT18A	0	T		C7	PT18A	0	T	
GND	GND0	0			GND	GND0	0		
A4	PT17B	0	C		A4	PT17B	0	C	
B4	PT17A	0	T		B4	PT17A	0	T	
C4	PT16B	0	C		C4	PT16B	0	C	
C5	PT16A	0	T		C5	PT16A	0	T	
D6	PT15B	0	C		D6	PT15B	0	C	
B5	PT15A	0	T		B5	PT15A	0	T	
E6	PT14B	0	C		E6	PT14B	0	C	
C6	PT14A	0	T	TDQS14	C6	PT14A	0	T	TDQS14
A3	PT13B	0	C		A3	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
B3	PT13A	0	T		B3	PT13A	0	T	
F6	PT12B	0	C		F6	PT12B	0	C	
D5	PT12A	0	T		D5	PT12A	0	T	
F7	PT11B	0	C		F7	PT11B	0	C	
E8	PT11A	0	T		E8	PT11A	0	T	
G6	PT10B	0	C		G6	PT10B	0	C	
E7	PT10A	0	T		E7	PT10A	0	T	
GND	GND0	0			GND	GND0	0		
GND	GND0	0			GND	GND0	0		
A1	GND	-			A1	GND	-		
A22	GND	-			A22	GND	-		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
AB1	GND	-			AB1	GND	-		
AB22	GND	-			AB22	GND	-		
H15	GND	-			H15	GND	-		
H8	GND	-			H8	GND	-		
J10	GND	-			J10	GND	-		
J11	GND	-			J11	GND	-		
J12	GND	-			J12	GND	-		
J13	GND	-			J13	GND	-		
J14	GND	-			J14	GND	-		
J9	GND	-			J9	GND	-		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K9	GND	-			K9	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L9	GND	-			L9	GND	-		
M10	GND	-			M10	GND	-		
M11	GND	-			M11	GND	-		
M12	GND	-			M12	GND	-		
M13	GND	-			M13	GND	-		
M14	GND	-			M14	GND	-		
M9	GND	-			M9	GND	-		
N10	GND	-			N10	GND	-		
N11	GND	-			N11	GND	-		
N12	GND	-			N12	GND	-		
N13	GND	-			N13	GND	-		
N14	GND	-			N14	GND	-		
N9	GND	-			N9	GND	-		
P10	GND	-			P10	GND	-		
P11	GND	-			P11	GND	-		
P12	GND	-			P12	GND	-		
P13	GND	-			P13	GND	-		
P14	GND	-			P14	GND	-		
P9	GND	-			P9	GND	-		
R15	GND	-			R15	GND	-		
R8	GND	-			R8	GND	-		
J16	VCC	-			J16	VCC	-		
J7	VCC	-			J7	VCC	-		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
E24	NC	-			E24	PR8B	2	C	
D24	NC	-			D24	PR8A	2	T	
E22	NC	-			E22	PR7B	2	C	
F22	NC	-			F22	PR7A	2	T	
E21	NC	-			E21	PR6B	2	C	
D22	NC	-			D22	PR6A	2	T	RDQS6
E23	PR2B	2	C	VREF1_2	E23	PR2B	2	C	VREF1_2
D23	PR2A	2	T	VREF2_2	D23	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
G20	NC	-			G20	PT65B	1	C	
F20	NC	-			F20	PT65A	1	T	
D21	NC	-			D21	PT64B	1	C	
C21	NC	-			C21	PT64A	1	T	
C23	NC	-			C23	PT63B	1	C	
C22	NC	-			C22	PT63A	1	T	
B23	NC	-			B23	PT62B	1	C	
C24	NC	-			C24	PT62A	1	T	TDQS62
D20	NC	-			D20	PT61B	1	C	
-	-	-			GND	GND1	1		
E19	NC	-			E19	PT61A	1	T	
B25	NC	-			B25	PT60B	1	C	
B24	NC	-			B24	PT60A	1	T	
B26	NC	-			B26	PT59B	1	C	
A25	NC	-			A25	PT59A	1	T	
C20	NC	-			C20	PT58B	1	C	
C19	NC	-			C19	PT58A	1	T	
A24	PT57B	1	C		A24	PT57B	1	C	
-	-	-			GND	GND1	1		
A23	PT57A	1	T		A23	PT57A	1	T	
E18	PT56B	1	C		E18	PT56B	1	C	
D19	PT56A	1	T		D19	PT56A	1	T	
F19	PT55B	1	C		F19	PT55B	1	C	
B22	PT55A	1	T		B22	PT55A	1	T	
G19	PT54B	1	C		G19	PT54B	1	C	
B21	PT54A	1	T	TDQS54	B21	PT54A	1	T	TDQS54
D18	PT53B	1	C		D18	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
C18	PT53A	1	T		C18	PT53A	1	T	
F18	PT52B	1	C		F18	PT52B	1	C	
A22	PT52A	1	T		A22	PT52A	1	T	
G18	PT51B	1	C		G18	PT51B	1	C	

LatticeECP/EC Family Data Sheet Ordering Information

Part Number Description

LFXXX XX X – X XXXX X

Device Family
- Lattice EC (FPGA)
- Lattice ECP (EC FPGA + DSP Blocks)

Logic Capacity
- 1* = 1.5K LUTs
- 3* = 3K LUTs
- 6 = 6K LUTs
- 10 = 10K LUTs
- 15 = 15K LUTs
- 20 = 20K LUTs
- 33 = 33K LUTs

Supply Voltage
- E = 1.2V

Grade
- C = Commercial
- I = Industrial

Package
- T100 = 100-pin TQFP*
- T144 = 144-pin TQFP
- Q208 = 208-pin PQFP
- F256 = 256-ball fpBGA
- F484 = 484-ball fpBGA
- F672 = 672-ball fpBGA
- TN100 = 100-pin Lead-free TQFP*
- TN144 = 144-pin Lead-free TQFP
- QN208 = 208-pin Lead-free PQFP
- FN256 = 256-ball Lead-free fpBGA
- FN484 = 484-ball Lead-free fpBGA
- FN672 = 672-ball Lead-free fpBGA

Speed
- 3 = Slowest
- 4
- 5 = Fastest

*Not available in the LatticeECP Family.

Ordering Information

Note:þLatticeECP/EC devices are dual marked. For example, the commercial speed grade LFEC20E-4F484C is also marked with industrial grade -3I (LFEC20E-3F484I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-4F256C	195	-4	fpBGA	256	COM	10.2K
LFEC10E-5F256C	195	-5	fpBGA	256	COM	10.2K
LFEC10E-3Q208C	147	-3	PQFP	208	COM	10.2K
LFEC10E-4Q208C	147	-4	PQFP	208	COM	10.2K
LFEC10E-5Q208C	147	-5	PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC15E-3F484C	352	-3	fpBGA	484	COM	15.3K
LFEC15E-4F484C	352	-4	fpBGA	484	COM	15.3K
LFEC15E-5F484C	352	-5	fpBGA	484	COM	15.3K
LFEC15E-3F256C	195	-3	fpBGA	256	COM	15.3K
LFEC15E-4F256C	195	-4	fpBGA	256	COM	15.3K
LFEC15E-5F256C	195	-5	fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC20E-3F672C	400	-3	fpBGA	672	COM	19.7K
LFEC20E-4F672C	400	-4	fpBGA	672	COM	19.7K
LFEC20E-5F672C	400	-5	fpBGA	672	COM	19.7K
LFEC20E-3F484C	360	-3	fpBGA	484	COM	19.7K
LFEC20E-4F484C	360	-4	fpBGA	484	COM	19.7K
LFEC20E-5F484C	360	-5	fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F672C	496	-3	fpBGA	672	COM	32.8K
LFEC33E-4F672C	496	-4	fpBGA	672	COM	32.8K
LFEC33E-5F672C	496	-5	fpBGA	672	COM	32.8K
LFEC33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFEC33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFEC33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeEC Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC15E-3F484I	352	-3	fpBGA	484	IND	15.3K
LFEC15E-4F484I	352	-4	fpBGA	484	IND	15.3K
LFEC15E-3F256I	195	-3	fpBGA	256	IND	15.3K
LFEC15E-4F256I	195	-4	fpBGA	256	IND	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC20E-3F672I	400	-3	fpBGA	672	IND	19.7K
LFEC20E-4F672I	400	-4	fpBGA	672	IND	19.7K
LFEC20E-3F484I	360	-3	fpBGA	484	IND	19.7K
LFEC20E-4F484I	360	-4	fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F672I	496	-3	fpBGA	672	IND	32.8
LFEC33E-4F672I	496	-4	fpBGA	672	IND	32.8
LFEC33E-3F484I	360	-3	fpBGA	484	IND	32.8
LFEC33E-4F484I	360	-4	fpBGA	484	IND	32.8

LatticeECP Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFECP6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFECP6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFECP6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFECP6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFECP6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFECP6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFECP6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFECP10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFECP10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFECP10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFECP10E-3Q208I	147	-3	PQFP	208	IND	10.2K
LFECP10E-4Q208I	147	-4	PQFP	208	IND	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP15E-3F484I	352	-3	fpBGA	484	IND	15.3K
LFECP15E-4F484I	352	-4	fpBGA	484	IND	15.3K
LFECP15E-3F256I	195	-3	fpBGA	256	IND	15.3K
LFECP15E-4F256I	195	-4	fpBGA	256	IND	15.3K

Date	Version	Section	Change Summary
September 2005	02.0	Architecture	sysIO section has been updated.
		DC & Switching Characteristics	Recommended Operating Conditions has been updated with V_{CCPLL}.
			DC Electrical Characteristics table has been updated
			Removed 5V Tolerant Input Buffer section.
			Register-to-Register performance table has been updated (rev. G 0.28).
			LatticeECP/EC External Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Internal Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Family Timing Adders have been updated (rev. G 0.28).
			sysCLOCK PLL timing table has been updated (rev. G 0.28)
			LatticeECP/EC sysCONFIG Port Timing specification table has been updated (rev. G 0.28).
			Master Clock table has been updated (rev. G 0.28).
			JTAG Port Timing specification table has been updated (rev. G 0.28).
		Pinout Information	Signal Description table has been updated with V_{CCPLL}.
November 2005	02.1	DC & Switching Characteristics	Pin-to-Pin Performance table has been updated (G 0.30) - 4:1MUX, 8:1MUX, 16:1MUX, 32:1MUX Register-to-Register Performance (G 0.30) - No timing number changes.
			External Switching Characteristics (G 0.30) - No timing number changes.
			Internal Switching Characteristics (G 0.30) -t_{SUP_DSP}, t_{HP_DSP}, t_{SUO_DSP}, t_{HO_DSP}, t_{COI_DSP}, t_{COD_DSP} numbers have been updated.
			Family Timing Adders (G 0.30) - No timing number changes.
			sysCLOCK PLL Timing (G 0.30) - No timing number changes.
			sysCONFIG Port Timing Specifications (G 0.30) - No timing number changes.
			Master Clock (G 0.30) - No timing number changes.
			JTAG Port Timing Specification (G 0.30) - No timing number changes.
		Ordering Information	Added 208-PQFP lead-free part numbers.
March 2006	02.2	DC & Switching Characteristics	Added footnote 3. to V_{CCAUX} in the Recommended Operating Conditions table.
January 2007	02.3	Architecture	EBR Asynchronous Reset section added.
February 2007	02.4	Architecture	Updated EBR Asynchronous Reset section.
			Updated Maximum Number of Elements in a Block table - MAC value for x9 changed to 2.
May 2007	02.5	Architecture	Updated text in Ripple Mode section.
November 2007	02.6	DC & Switching Characteristics	Added JTAG Port Waveforms diagram.
			Updated t_{RST} timing information in the sysCLOCK PLL Timing table.
		Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
February 2008	02.7	DC & Switching Characteristics	Read/Write Mode (Normal) and Read/Write Mode with Input and Output Registers waveforms in the EBR Memory Timing Diagrams section have been updated.
September 2012	02.8	All	Updated document with new corporate logo.